



# STV7697

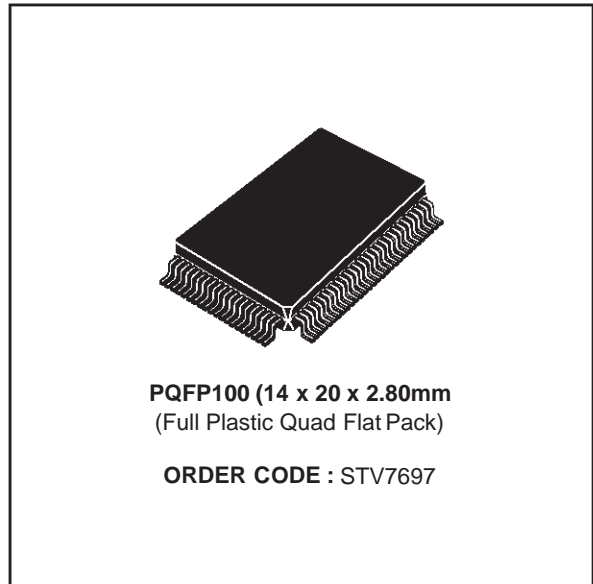
## PLASMA DISPLAY PANEL SCAN DRIVER

PRODUCT PREVIEW

- 64 OUTPUTS PLASMA DISPLAY DRIVER
- 170V ABSOLUTE MAXIMUM SUPPLY
- 5V SUPPLY FOR LOGIC
- 40/200mA SOURCE / SINK OUTPUT
- 400mA SOURCE / SINK OUTPUT DIODE
- 64-BIT SHIFT REGISTER (20MHz)
- BLANK CONTROL
- COMPLEMENTARY OUTPUT CONTROL
- BCD TECHNOLOGY
- 100 PINS PQFP PACKAGE OR DICE

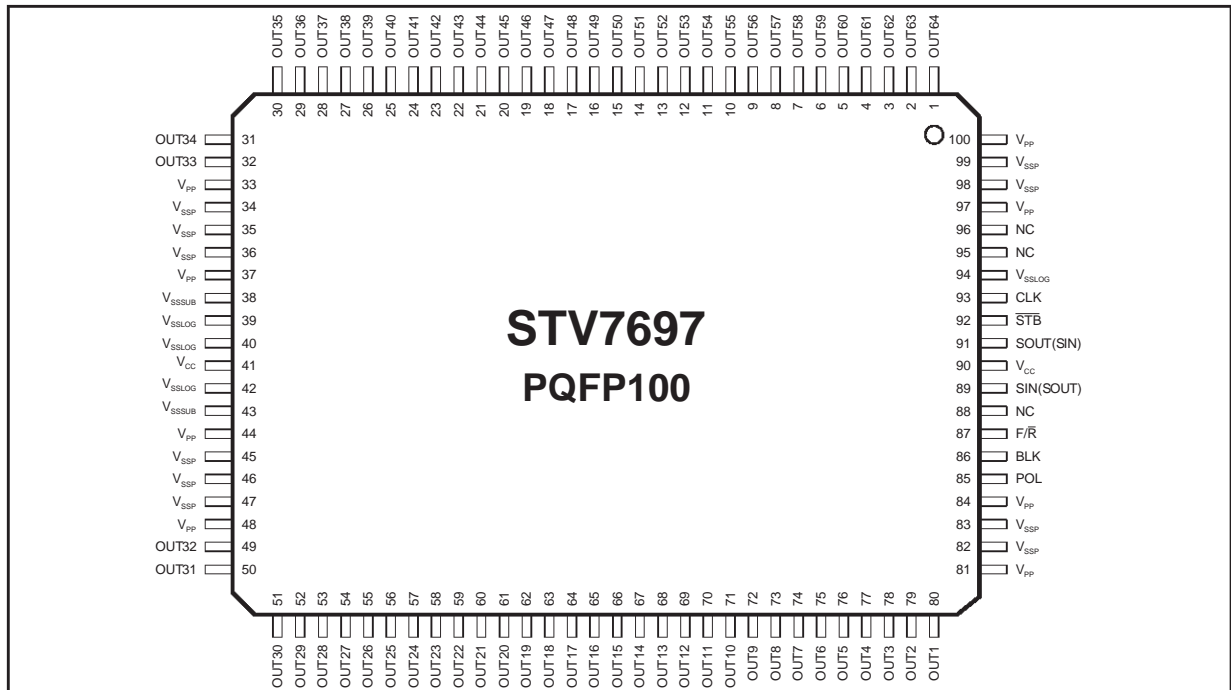
### DESCRIPTION

The STV7697 is a scan driver for Plasma Display Panel (PDP) implemented in SGS-THOMSON's proprietary BCD technology. Using a 64-bit cascaded 20MHz shift register, it drives 64 high current & high voltage outputs. By serially connecting several STV7697, any vertical pixel definition can be performed. The STV7697 is supplied with a separated 160V power output supply and a 5V logic supply.



All command inputs are CMOS compatible. The STV7697 package is a 100 pins PQFP.

### PIN CONNECTIONS



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## PIN ASSIGNMENT (PQFP100)

Pin Number	Symbol	Type	Function
33-37-44-48-81-84-97-100	V <sub>PP</sub>	Supply	High Voltage Supply of power outputs
41-90	V <sub>CC</sub>	Supply	5V Logic Supply
34-35-36-45-46-47-82-83-98-99	V <sub>SSP</sub>	Ground	Ground of power outputs
38-43	V <sub>SSSUB</sub>	Ground	Substrate Ground
39-40-42-94	V <sub>SSLOG</sub>	Ground	Logic Ground
1 to 32, 49 to 80	OUT64 to OUT 1	Output	Power Output
91	SOUT (SIN)	Output	Shift Register Data Output (forward)
85	POL	Input	Polarity Selection
86	BLK	Input	Output Blanking Command
87	F/R	Input	Selection of shift direction
89	SIN (SOUT)	Input	Shift Register Data Input (forward)
92	STB	Input	Latch of data to outputs
93	CLK	Input	Clock of data shift register
88-95-96	NC	-	

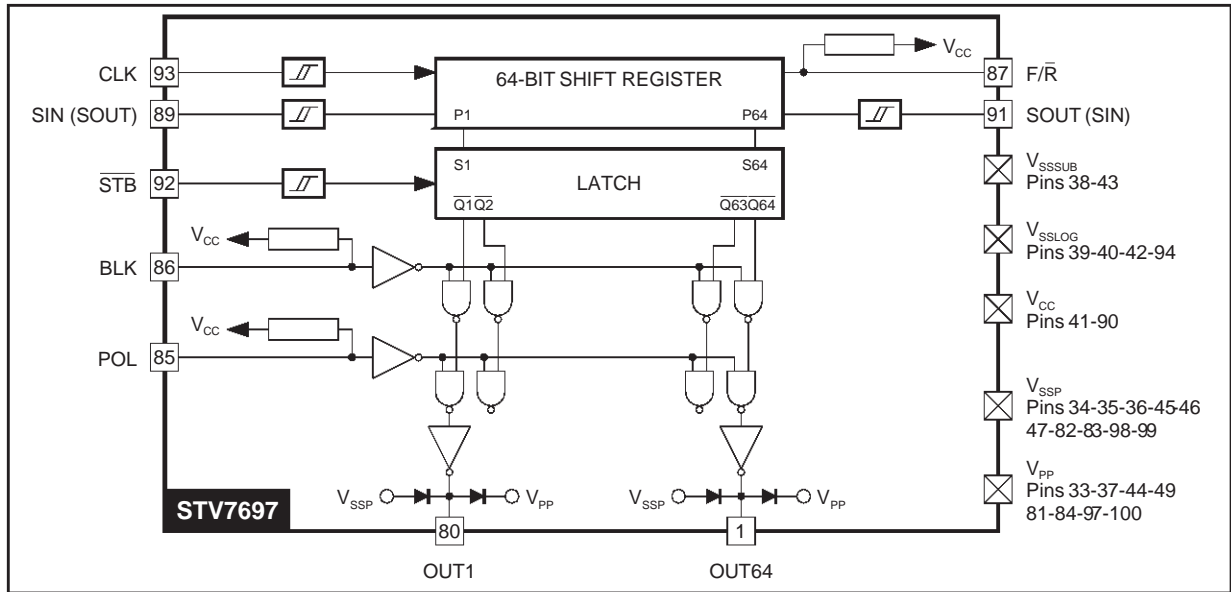
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## PIN ASSIGNMENT (Power Outputs)

Output N°	Pin N°	Output N°	Pin N°	Output N°	Pin N°	Output N°	Pin N°
1	80	17	64	33	32	49	16
2	79	18	63	34	31	50	15
3	78	19	62	35	30	51	14
4	77	20	61	36	29	52	13
5	76	21	60	37	28	53	12
6	75	22	59	38	27	54	11
7	74	23	58	39	26	55	10
8	73	24	57	40	25	56	9
9	72	25	56	41	24	57	8
10	71	26	55	42	23	58	7
11	70	27	54	43	22	59	6
12	69	28	53	44	21	60	5
13	68	29	52	45	20	61	4
14	67	30	51	46	19	62	3
15	66	31	50	47	18	63	2
16	65	32	49	48	17	64	1

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**BLOCK DIAGRAM**



**CIRCUIT DESCRIPTION**

The STV7697 contains all the logic and the power circuits necessary to drive rows of a Plasma Display Panel (P. D. P.). The state of the displayed line is loaded into the shift register. Data are shifted at each low to high transition of the (CLK) shift clock. After 64 shifts the first bit is available at the serial output. This output can be used to cascade several drivers to perform any vertical resolution.

The forward/reverse (F/R) input is used to select the direction of the shift register, data input/output status is set according to the selected direction. SIN, CLK, STB inputs are Smith trigger inputs. If not used on the application, F/R, BLK, POL logical inputs are internally pulled to level "1". The maximum frequency of the shift clock is 20MHz.

All the the data are memorized into the latch stage when the strobe input (STB) is pulled high.

Blanking input (BLK) forces the power outputs to high level when pulled high with polarity input (POL)

at high level and forced to low level with POL at low level.

The level of the power output is inverted when the polarity command (POL) is pulled high.

Sustain current must not be sunk in the power output to V<sub>PP</sub> when the power supply is applied.

V<sub>SSLOG</sub> and V<sub>SSSUB</sub> must be connected as close as possible to the logical reference ground of the application.

**Shift Register Truth Table**

Input		Input/Output		Shift Register Function
F/R	CLK	SIN	SOUT	Output Q
H	Rise	IN	OUT	Forward shift
H	H or L	IN	OUT	Steady
L	Rise	OUT	IN	Reverse Shift
L	H or L	OUT	IN	Steady

**Power Output Truth Table**

Qn (1)	STB	BLK	POL	Driver Output	Comments
X	X	H	H	All H	Forced to High
X	X	H	L	All L	Forced to Low
H	L	L	L	H	Copy Data
L	L	L	L	L	Copy Data
H	L	L	H	L	Copy Inverted Data
L	L	L	H	H	Copy Inverted Data
X	H	L	L	Qn	Data Latched
X	H	L	H	Qn	Inverted Data Latched

**Note :** 1. Qn is the parallel output of the shift register (n = 1 to 64). Qn takes the value of serial input (SIN) after "n" shift clock periods.



## ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
V <sub>CC</sub>	Logic Supply Range	-0.3, +7	V
V <sub>PP</sub>	Driver Supply Range	-0.3, +170	V
V <sub>IN</sub>	Logic Input Voltage Range	-0.3, V <sub>CC</sub> + 0.3	V
V <sub>OUT</sub>	Logic Output Voltage Range	-0.3, V <sub>CC</sub> + 0.3	V
V <sub>POUT</sub>	Driver Output Voltage Range	-0.3, V <sub>PP</sub>	V
I <sub>POUT</sub>	Driver Output Current (2)(4)	+50/-250	mA
I <sub>DOUT</sub>	Diode Output Current (3)(4)	±500	mA
T <sub>oper</sub>	Operating Temperature	-20, +85	°C
T <sub>j</sub>	Junction Temperature (1)	+125	°C
T <sub>stg</sub>	Storage Temperature	-50, +150	C

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## THERMAL DATA

Symbol	Parameter	Value	Unit
R <sub>th(j-a)</sub>	Junction-ambient Thermal Resistance (1) Max.	50	°C/W
P <sub>oper</sub>	Maximum Operating Power Dissipation (T <sub>amb</sub> = 25°C)	2	W

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- Notes : 1. For PQFP100 packaging.  
 2. Through one power output.  
 3. Through one power output with V<sub>PP</sub> = V<sub>SSP</sub> (see test diagram).  
 4. These parameters are measured during ST's internal qualification which includes temperature characterisation on standard batches and on corners batches of the process. These parameters are not tested on the parts.

## ELECTRICAL CHARACTERISTICS

(V<sub>CC</sub> = 5V, V<sub>PP</sub> = 130V, V<sub>SSP</sub> = 0V, V<sub>SSLOG</sub> = V<sub>SSSUB</sub> = 0V, T<sub>amb</sub> = 25°C, f<sub>CLK</sub> = 20MHz, unless otherwise specified)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
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## SUPPLY

V <sub>CC</sub>	Logic Supply Voltage		4.5	5	5.5	V
I <sub>CCH</sub>	Logic Supply Current (all inputs high)		-	-	10	µA
I <sub>CCL</sub>	Logic Supply Current	f <sub>CLK</sub> = 8MHz, SIN = 1010	-	5.3	TBD	mA
V <sub>PP</sub>	Power Output Supply Voltage		TBD	-	160	V
I <sub>PPH</sub>	Power Output Supply Current (steady outputs)		-	-	100	µA

## OUTPUT

OUT1-OUT64						
V <sub>POUTH</sub>	Power Output High Level	I <sub>POUTH</sub> = -10mA I <sub>POUTH</sub> = -40mA	120 TBD	- 125	- -	V V
V <sub>POUTL</sub>	Power Output Low Level	I <sub>POUTL</sub> = 200mA	-	3	10	V
V <sub>DOUTH</sub>	Output Diode High Level	I <sub>DOUTH</sub> = +400mA (5)	-	1.7	10	V
V <sub>DOUTL</sub>	Output Diode Low Level	I <sub>DOUTL</sub> = -400mA (5)	-	-1.4	-10	V
SOUT						
V <sub>OH</sub>	Logic Output High Level	I <sub>OH</sub> = 1mA	4	-	-	V
V <sub>OL</sub>	Logic Output Low Level	I <sub>OL</sub> = -1mA	-	-	0.4	V

INPUT (CLK, F/R,  $\overline{\text{STB}}$ , POL, BLK, SIN)

V <sub>IH</sub>	Input High Level		0.8 V <sub>CC</sub>	-	-	V
V <sub>IL</sub>	Input Low Level		-	-	0.2 V <sub>CC</sub>	V
I <sub>IH</sub>	High Level Input Current	V <sub>IH</sub> = V <sub>CC</sub>	-	-	10	µA
I <sub>IL</sub>	Low Level Input Current CLK, SIN, $\overline{\text{STB}}$ F/R, BLK, POL	V <sub>IL</sub> = 0V	-	- 70	10 100	µA µA

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- Notes : 5. Compatible with power dissipation (see test diagram).

**AC TIMINGS REQUIREMENTS**

( $V_{CC} = 4.5V$  to  $5.5V$ ,  $T_{amb} = -20$  to  $+85^{\circ}C$ , input signals max leading edge & trailing edge ( $t_R$ ,  $t_F$ ) = 10ns)

Symbol	Parameter	Min.	Typ.	Max.	Unit
$t_{CLK}$	Data Clock Period	50	-	-	ns
$t_{WHCLK}$	Duration of clock (CLK) pulse at high level	15	-	-	ns
$t_{WLCLK}$	Duration of clock (CLK) pulse at low level	15	-	-	ns
$t_{SDAT}$	Set-up Time of data input before clock low to high transition	10	-	-	ns
$t_{HDAT}$	Hold Time of data input after clock low to high transition	10	-	-	ns
$t_{SFR}$	Forward/Reverse ( $F/\bar{R}$ ) set up time before low to high clock transition	100	-	-	ns
$t_{DSTB}$	Minimum Delay to latch ( $\overline{STB}$ ) after clock low to high transition	10	-	-	ns
$t_{STB}$	Strobe ( $\overline{STB}$ ) Pulse Duration	20	-	-	ns
$t_{BLK}$	Blank (BLK) Pulse Duration	500	-	-	ns
$t_{POL}$	Polarity (POL) Pulse Duration	500	-	-	ns

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**AC TIMING CHARACTERISTICS**

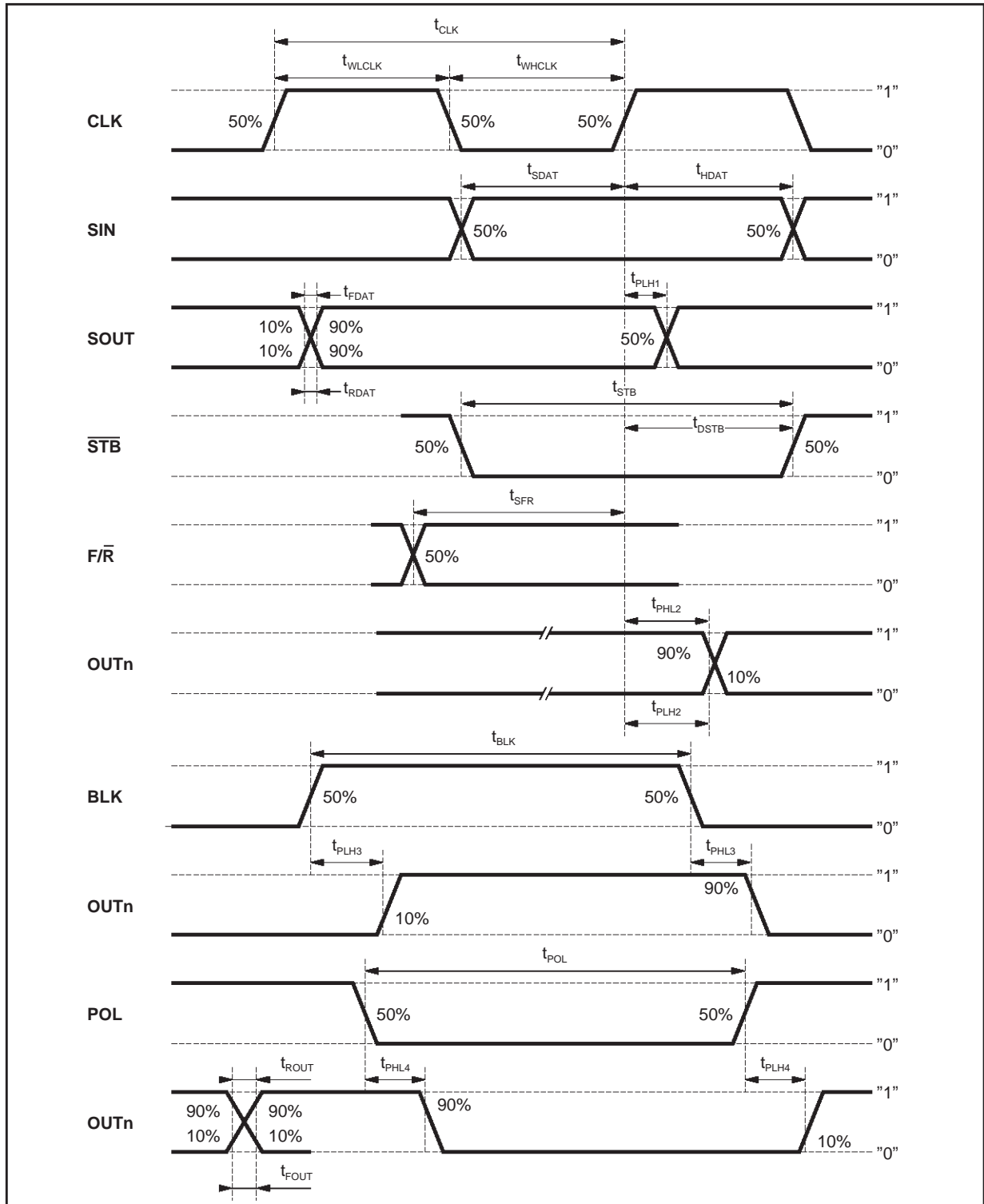
( $V_{CC} = 5V$ ,  $V_{PP} = 130V$ ,  $V_{SSP} = 0V$ ,  $V_{SSLOG} = V_{SSSUB} = 0V$ ,  $T_{amb} = 25^{\circ}C$ ,  $f_{CLK} = 20MHz$ ,  $V_{ILMax.} = 0.2V_{CC}$ ,  $V_{IHMin.} = 0.8V_{CC}$ ,  $V_{OH} = 4.0V$ ,  $V_{OL} = 0.4V$ ,  $C_L = 15pF$ , unless otherwise specified)

Symbol	Parameter	Min.	Typ.	Max.	Unit
$t_{CLK}$	Data Clock Period	50	-	-	ns
$t_{RDAT}$ $t_{FDAT}$	Logical Data Output Rise Time Logical Data Output Fall Time	- -	20 11	- -	ns ns
$t_{PHL1}$ $t_{PLH1}$	Delay of logic data output after clock (CLK) high to low transition Delay of logic data output after clock (CLK) low to high transition	- -	45 48	- -	ns ns
$t_{PHL2}$ $t_{PLH2}$	Delay of power output change after clock (CLK) high to low transition Delay of power output change after clock (CLK) low to high transition	- -	120 120	180 180	ns ns
$t_{PHL3}$ $t_{PLH3}$	Delay of power output change after blanking (BLK) high to low transition Delay of power output change after blanking (BLK) low to high transition	- -	110 110	165 165	ns ns
$t_{PHL4}$ $t_{PLH4}$	Delay of power output change after polarity (POL) high to low transition Delay of power output change after polarity (POL) low to high transition	- -	- -	160 160	ns ns
$t_{ROUT}$ $t_{FOUT}$	Power Output Rise Time (6) Power Output Fall Time (6)	- -	100 60	200 200	ns ns

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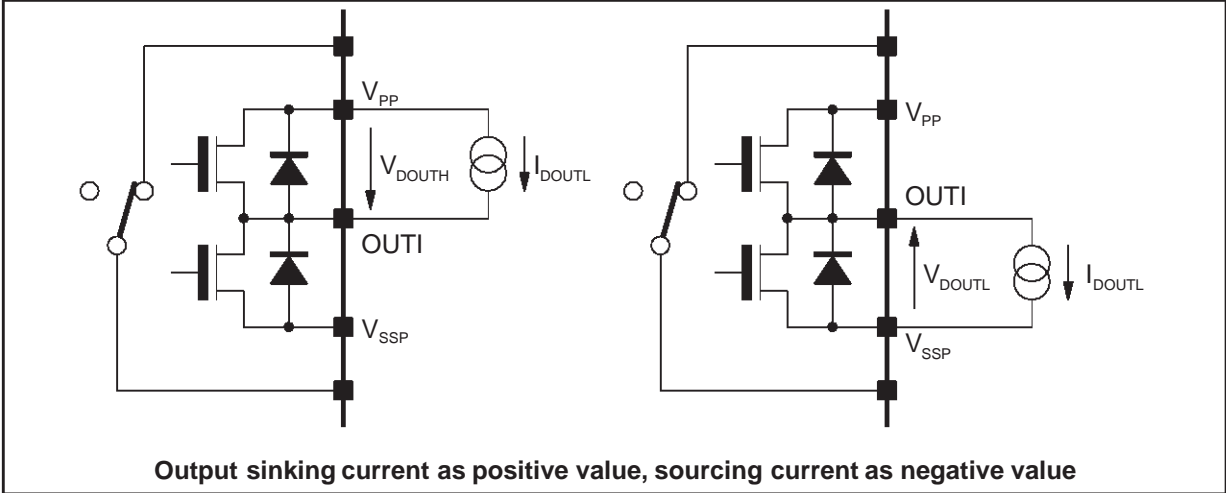
**Notes :** 6. One output among 64, loading capacitor  $C_{OUT} = 100pF$ , other outputs at low level.

Figure 1 : AC Characteristics Waveform



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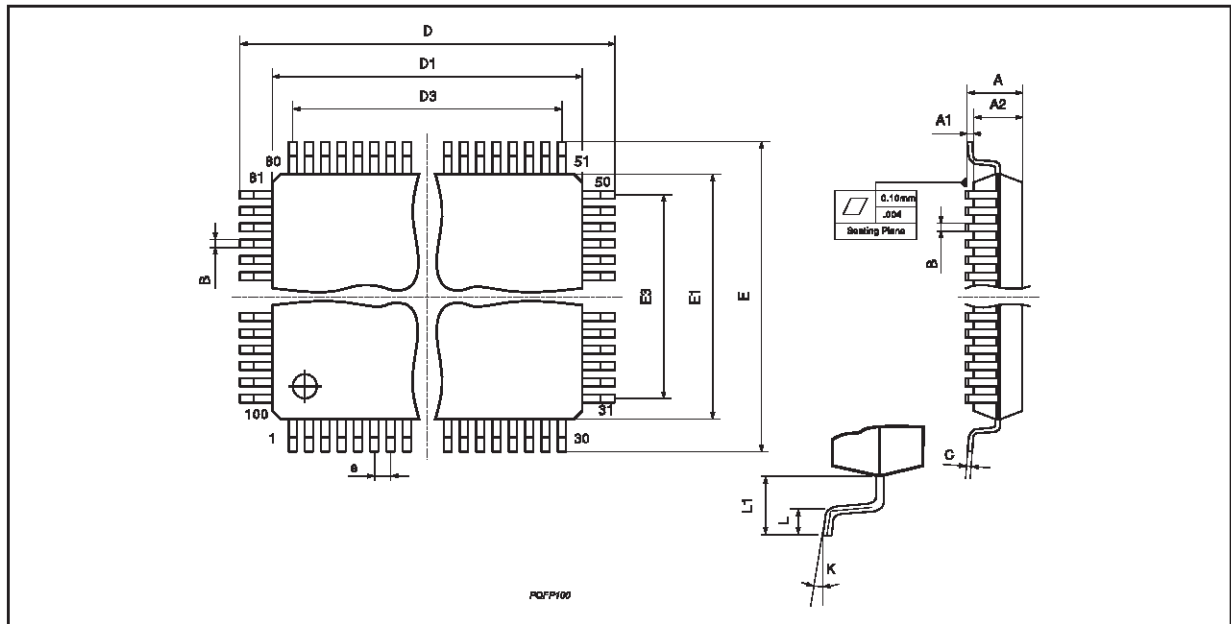
Figure 2 : Test Configuration



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**PACKAGE MECHANICAL DATA**

100 PINS - PLASTIC QUAD FLAT PACK (PQFP100)



Dimensions	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A			3.40			0.134
A1	0.25			0.010		
A2	2.55	2.80	3.05	0.100	0.110	0.120
B	0.22		0.38	0.0087		0.015
C	0.13		0.23	0.005		0.009
D	22.95	23.20	23.45	0.903	0.913	0.923
D1	19.90	20.00	20.10	0.783	0.787	0.791
D3		18.85			0.742	
e		0.65			0.026	
E	16.95	17.20	17.45	0.667	0.677	0.687
E1	13.90	14.00	14.10	0.547	0.551	0.555
E3		12.35			0.486	
L	0.65	0.80	0.95	0.026	0.0315	0.0374
L1		1.60			0.063	
K	0° (Min.), 7° (Max.)					

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